

UC1573 UC2573 UC3573

Buck Pulse Width Modulator Stepdown Voltage Regulator

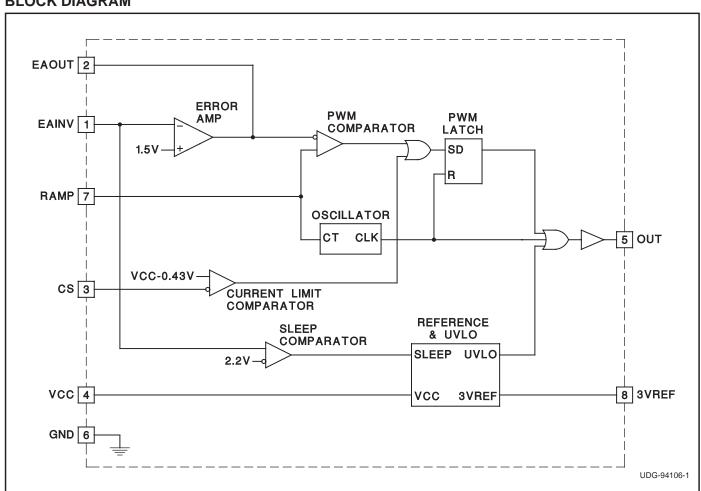
FEATURES

- Simple Single Inductor Buck PWM Stepdown Voltage Regulation
- Drives External PMOS Switch
- Contains UVLO Circuit
- Includes Pulse-by-Pulse Current Limit
- Low 50μA Sleep Mode Current

DESCRIPTION

The UC3573 is a Buck pulse width modulator which steps down and regulates a positive input voltage. The chip is optimized for use in a single inductor buck switching converter employing an external PMOS switch. The block diagram consists of a precision reference, an error amplifier configured for voltage mode operation, an oscillator, a PWM comparator with latching logic, and a 0.5A peak gate driver. The UC3573 includes an undervoltage lockout circuit to insure sufficient input supply voltage is present before any switching activity can occur, and a pulse-by-pulse current limit. Input current can be sensed and limited to a user determined maximum value. In addition, a sleep comparator interfaces to the UVLO circuit which turns the chip off when the input voltage is below the UVLO threshold. This reduces the supply current to only $50\mu\text{A}$, making the UC3573 ideal for battery powered applications.

BLOCK DIAGRAM

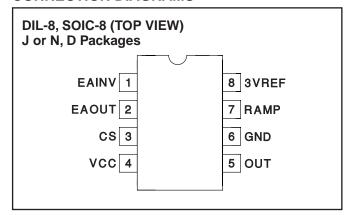


ABSOLUTE MAXIMUM RATINGS

VCC35V	/
EAINV0.6V to VCC)
I _{EAOUT}	4
RAMP	/
CS	
I _{OUT}	4
I _{3VREF}	4
Storage Temperature	2
Junction Temperature65°C to +150°C)
Lead Temperature (Soldering, 10 sec.)+300°C	2

Currents are positive into, negative out of the specified terminal. Consult Packaging Section of Databook for thermal limitations and considerations of packages.

CONNECTION DIAGRAMS



ELECTRICAL CHARACTERISTICS: Unless otherwise specified, these parameters apply for $T_A = -55^{\circ}C$ to $+125^{\circ}C$ for the UC1573, $-40^{\circ}C$ to $+85^{\circ}C$ for the UC2573, and $0^{\circ}C$ to $+70^{\circ}C$ for the UC3573, VCC = 5V, CT = 680pF, $T_A = T_J$.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Reference Section		•			
3VREF		2.94	3	3.06	V
Line Regulation	VCC = 4.75 to 30V		1	10	mV
Load Regulation	$I_{3VREF} = 0$ to $-5mA$		1	10	mV
Oscillator Section					
Frequency	V _{CC} = 5V, 30V	85	100	115	kHz
Error Amp Section					
EAINV	EAOUT = 2V	1.45	1.5	1.55	V
IEAINV	EAOUT = 2V		-0.2	-1	μΑ
AVOL	EAOUT = 0.5V to 3V	65	90		dB
EAOUT High	EAINV = 1.4V	3.6	4	4.4	V
EAOUT Low	EAINV = 1.6V		0.1	0.2	V
I _{EAOUT}	EAINV = 1.4V, EAOUT = 2V	-350	-500		μΑ
	EAINV = 1.6V, EAOUT = 2V	7	20		mA
Unity Gain Bandwidth	T _J = 25°C, F = 10kHz	0.6	1		MHz
Current Sense Comparator Section		<u>.</u>			
Threshold (referred to VCC)		-0.39	-0.43	-0.47	V
Input Bias Current	CS = VCC		150	800	nA
CS Propagation Delay			400		ns
Gate Drive Output Section		·			-
OUT High Saturation	I _{OUT} = 0		0	0.3	V
,	$I_{OUT} = -10$ mA		0.7	1.5	V
	$I_{OUT} = -100$ mA		1.5	2.5	V
OUT Low Saturation	I _{OUT} = 10mA		0.1	0.4	V
	$I_{OUT} = 100 \text{mA}$		1.5	2.2	V
Rise Time	$T_J = 25$ °C, $C_{LOAD} = 1$ nF + 3.3 Ohms		30	80	ns
Fall Time	$T_J = 25$ °C, $C_{LOAD} = 1$ nF + 3.3 Ohms		30	80	ns
Pulse Width Modulator Section					
Maximum Duty Cycle	EAINV = 1.4V		92	96	%
Minimum Duty Cycle	EAINV = 1.6V			0	%
Modulator Gain	EAOUT = 1.5V to 2.5V	25	35	45	%/V
Undervoltage Lockout Section					
Start Threshold		3.5	4.2	4.5	V
Hysteresis		100	200	300	mV

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PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Sleep Mode Section					
Threshold		1.8	2.2	2.6	V
Supply Current Section					
Ivcc	VCC = 30V		9	12	mA
Ivcc	VCC = 30V, EAINV = 3V		50	150	μА

PIN DESCRIPTIONS

3VREF: Precision 3V reference. Bypass with 100nF capacitor.

CS: Peak current limit sense pin. Senses the current across a current sense resistor placed between VCC and source of the PMOS Buck switch. OUT will be held high (PMOS buck switch off) if VCC – CS exceeds 0.4V.

EAINV: Inverting input to error amplifier. VOUT sense feedback connected to this pin. The non-inverting input of the error amplifier is internally connected to:

$$\frac{3VREF}{2}$$
 Volts.

Connecting the EAINV pin to an external voltage greater than 2.6V commands the chip to go into a low current sleep mode.

EAOUT: Output of error amplifier. Use EAOUT and EAINV for loop compensation components.

GND: Circuit Ground.

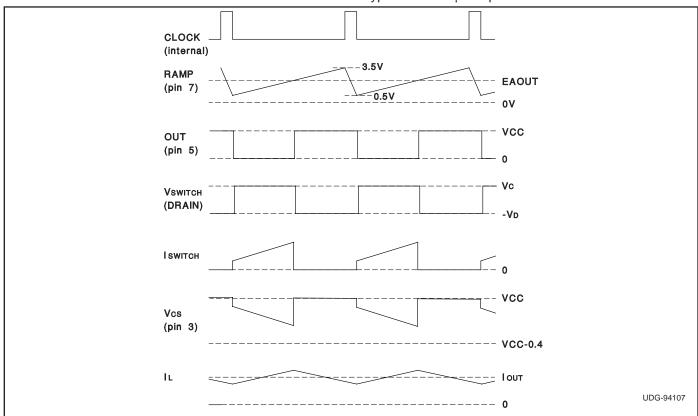
OUT: Gate drive for external PMOS switch connected between VCC and the flyback inductor. OUT drives the gate of the PMOS switch between VCC and GND.

RAMP: Oscillator and ramp for pulse width modulator. Frequency is set by a capacitor to GND by the equation

$$F = \frac{1}{15k \bullet C_{RAMP}}$$

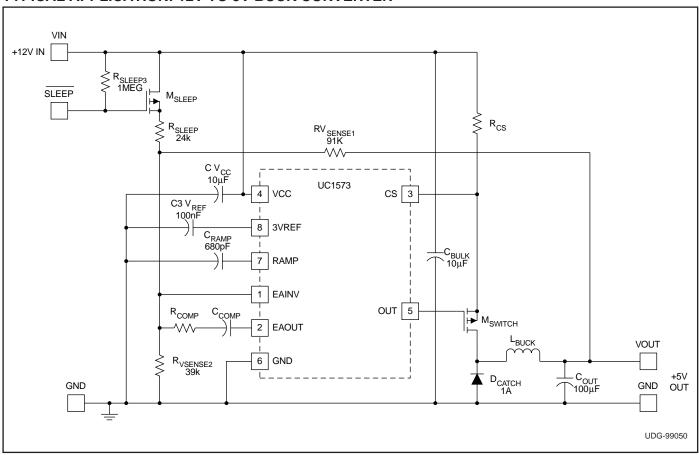
Recommended operating frequency range is 10kHz to 200kHz.

VCC: Input voltage supply to chip. Range is 4.75V to 30V. Bypass with a $1\mu F$ capacitor.



Typical Waveforms.

TYPICAL APPLICATION: 12V TO 5V BUCK CONVERTER



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